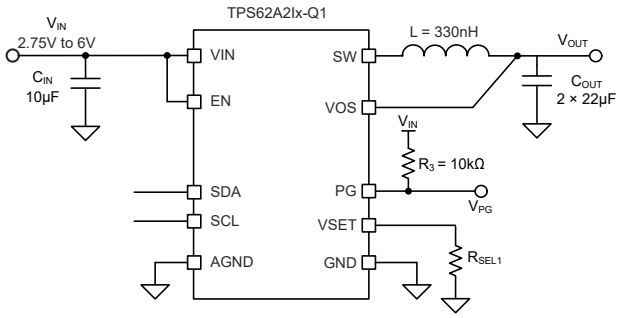
TPS62A2Ix-Q1: 2.75V to 6V Input, 1A, 2A, 3A, 4A, Automotive, Fast Transient, Synchronous Step-Down Converters With I²C Interface

1 Features

- AEC-Q100 qualified for automotive applications
  - Temperature grade 1: –40°C to +125°C T_A
- Functional Safety-Capable
  - Documentation available to aid functional safety system design
- Family of 1A, 2A, 3A, and 4A devices
- Input voltage range: 2.75V to 6V
- Output voltage from 0.4V to 3.6V
- Switching frequency from 1.5MHz to 4MHz
- Fast transient response with COT control
  - Fixed switching frequency during steady-state operation
  - 16 internal compensation settings to reduce output capacitance
- Low $R_{DS(on)}$ MOSFETS: 23mΩ and 15mΩ
- Minimum on-time of 30ns (maximum) at V_{IN} = 5V
- Selectable forced PWM mode through I²C
- Programmable spread spectrum clocking
- Adjustable soft-start, soft-stop timings
- Power-good output with window comparator
- Active output discharge
  - Supports programmable soft-stop feature
- I²C-compatible interface up to 1MHz
- 2.1mm × 2.1mm WQFN package with wettable flanks

2 Applications

- ADAS domain controller
- Digital cockpit processing unit
- Driver monitoring
- Front camera



Simplified Schematic for TPS62A2Ix-Q1

3 Description

The TPS62A2Ix-Q1 series are families of pin-to-pin compatible, high-efficiency, synchronous step-down DC-DC converters capable of delivering continuous output currents of 1A, 2A, 3A, and 4A. Using a constant on-time (COT) control topology, these devices provide fast transient response while maintaining fixed switching frequency operation during steady-state conditions.

To enhance loop performance, the devices offer 16 selectable internal compensation settings, enabling higher bandwidth and reducing output capacitance. Integrated low RDS(on) MOSFETs support continuous output up to 4A even at high ambient temperatures.

The switching frequency is adjustable from 1.5MHz to 4MHz. In PFM/PWM mode, the device automatically enters power-save mode at light loads to achieve high efficiency across the full load range. The device maintains the output voltage accuracy within ±0.8% in PWM mode for V_{OUT} ≥ 0.5V. The soft-start feature provides controlled power-up and limits inrush current, while the soft-stop feature enables coordinated power-down sequencing.

Device Information

PART NUMBER	OUTPUT CURRENT	PACKAGE(1)	PACKAGE SIZE(2)
TPS62A2I1-Q1(3)	1A	RZX (UQFN-FCRLF, 13)	2.1mm × 2.1mm
TPS62A2I2-Q1(3)	2A		
TPS62A2I3-Q1(3)	3A		
TPS62A2I4-Q1	4A		

(1) For more information, see Section 6.
(2) The package size (length × width) is a nominal value and includes pins, where applicable.
(3) Preview information (not Production Data).

An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, intellectual property matters and other important disclaimers. UNLESS OTHERWISE NOTED, this document contains PRODUCTION DATA.

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4 Device and Documentation Support

4.1 Device Support

4.1.1 Third-Party Products Disclaimer

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4.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

4.3 Support Resources

TI E2E™ support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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4.4 Trademarks

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4.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

4.6 Glossary

TI Glossary	This glossary lists and explains terms, acronyms, and definitions.

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5 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision * (December 2025) to Revision A (August 2026)	Page
• Changed the document status from Advance Information to Production Mix	1
• Updated the *Features* list to the production specifications	1
• Updated the *Description* to the production specifications	1
• Deleted the line "supports synchronization to an external clock" from the *Description*	1

6 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
XPS62A2I4AQWRZXRQ1	Active	Preproduction	UQFN-FCRLF (RZX) | 13	3000 | LARGE T&R	-	Call TI	Call TI	-40 to 125	

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

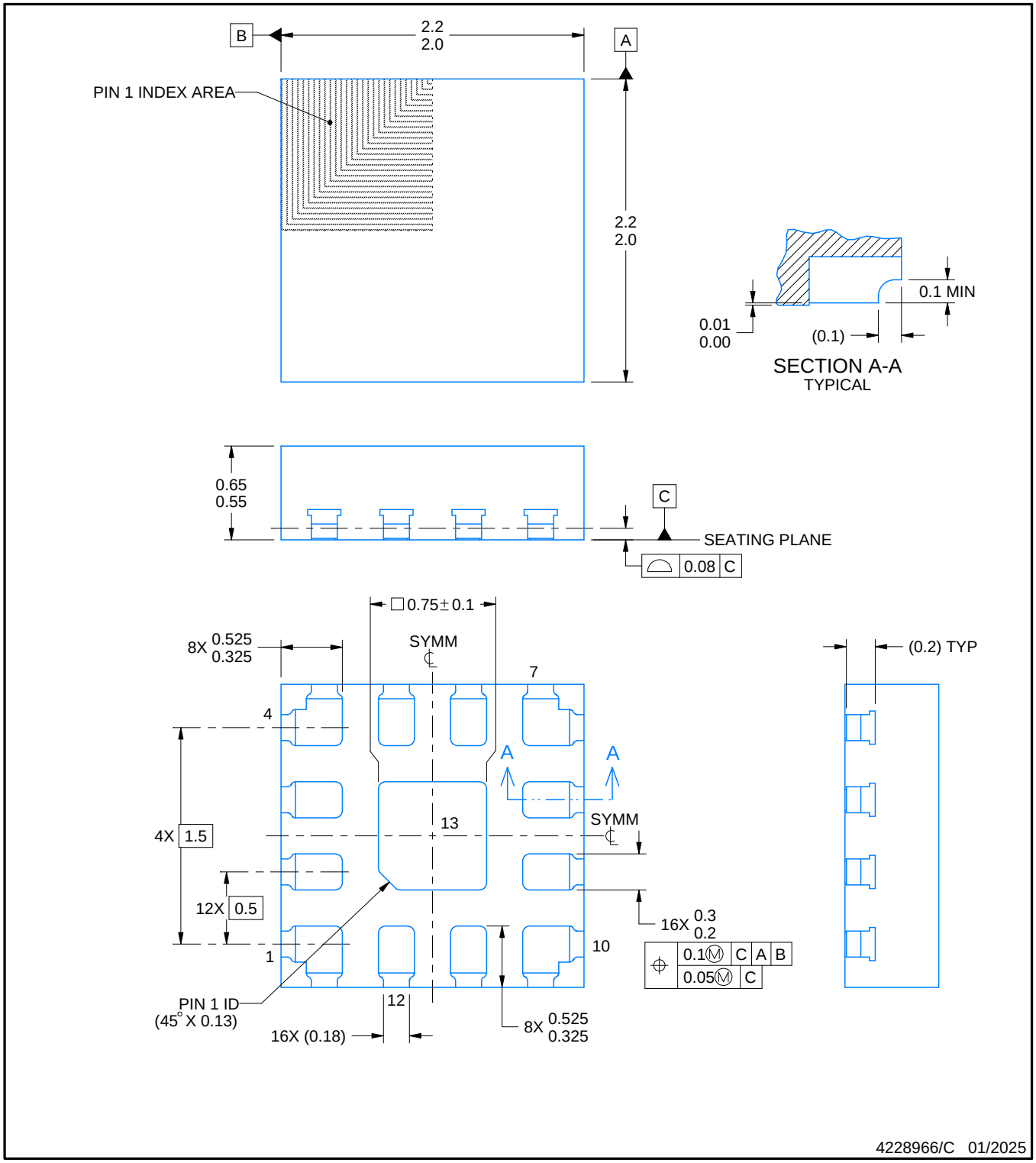
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PACKAGE OUTLINE

RZX0013A

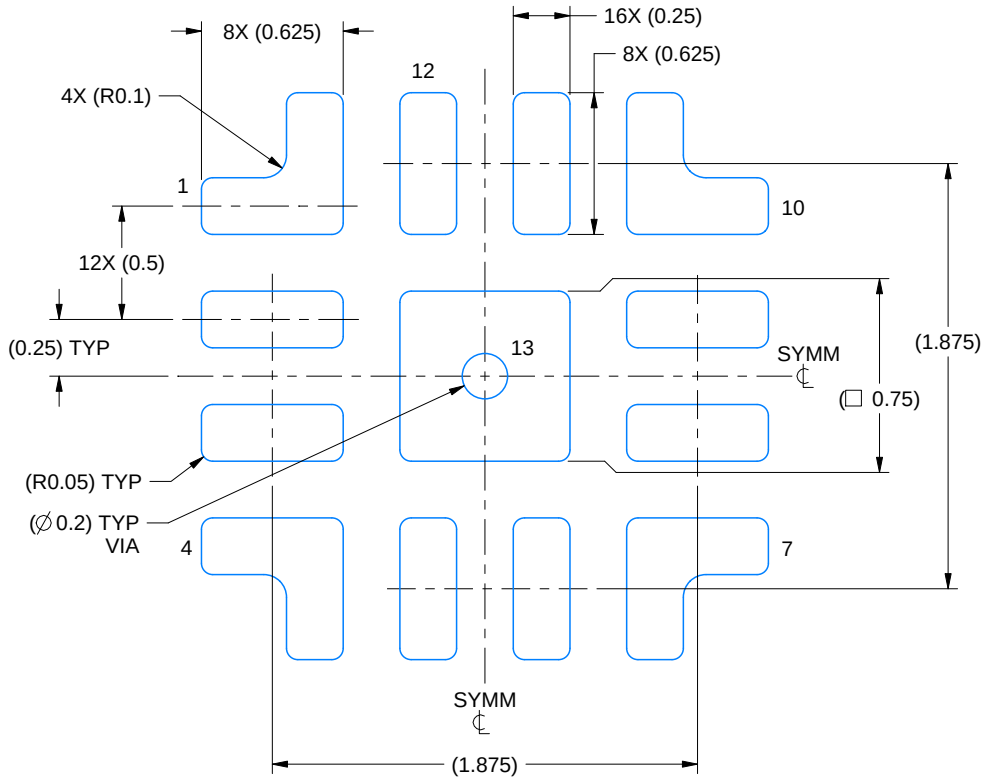
UQFN-FCRLF - 0.65 mm max height

PLASTIC QUAD FLATPACK - NO LEAD

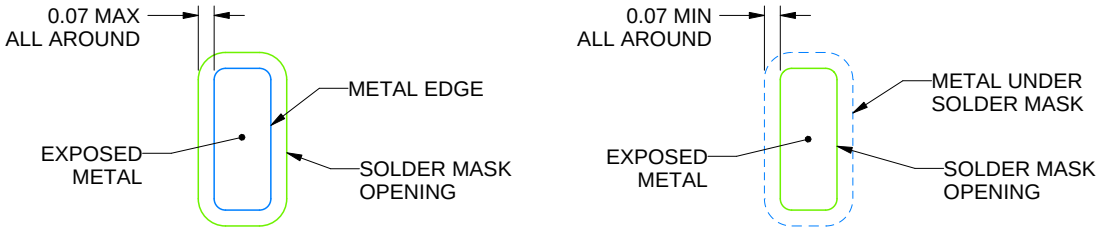


NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 30X



NON SOLDER MASK DEFINED (PREFERRED)

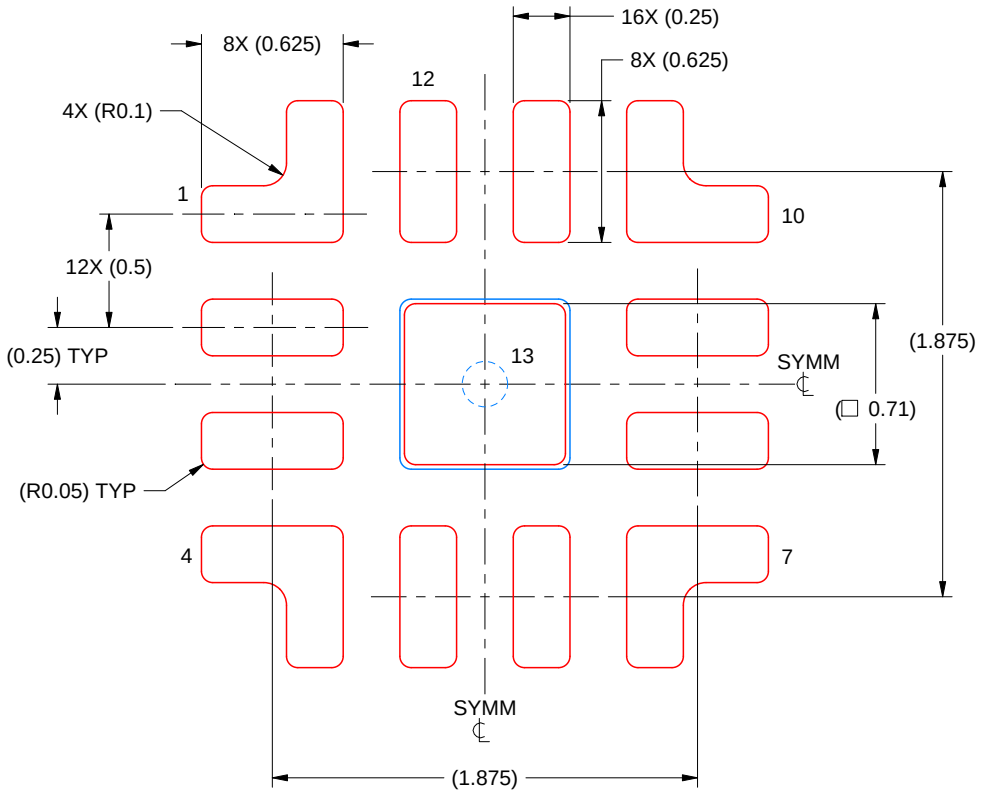
SOLDER MASK DEFINED

SOLDER MASK DETAILS

4228966/C 01/2025

NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
5. Vias are optional depending on application, refer to device data sheet. If some or all are implemented, recommended via locations are shown.



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE: 30X

SOLDER PASTE COVERAGE BY AREA UNDER PACKAGE
PAD 13: 90%

4228966/C 01/2025

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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